Docket No.

221014US90PC1

# TES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Yasuji HIRAMATSU, et al.

SERIAL NO:

10/070,443

GAU:

3742

FILED:

June 24, 2002

EXAMINER: FUQUA, SHAWNTINA T

FOR:

SEMICONDUCTOR MANUFACTURING/TESTING CERAMIC HEATER, PRODUCTION METHOD FOR THE

CERAMIC HEATER AND PRODUCTION SYSTEM FOR THE CERAMIC HEATER

# INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

RECEIVED

Applicant(s) wish to disclose the following information.

MAR 1 1 2004

TECHNOLOGY CENTER R3700

### REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

### RELATED CASES

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Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,

MAIER & NEUSTADT, P.C.

Masayasu Mori

Registration No. 47,301

Joseph A. Scafetta, Jr. Registration No. 26, 803

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**Customer Number** 

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

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LIST OF REFERENCES CITED BY APPLICANT				Yasuji HIRAMATSU, et al.				
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EXAMINER INITIAL	A	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE	
34/	AA	6,507,006	01/14/03	HIRAMATSU et al.				
70	AB	6,465,763	10/15/02	ITO et al.				
	AC	6,677,557	01/13/04	ITO et al.				
Wi	AD	6,475,606	11/05/02	NIWA				
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# **LIST OF RELATED CASES**

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Docket Number	Serial or Patent Number	Filing or Issue Date	Inventor/ Applicant
221014US2 PCT*	10/070,443	06/24/02	HIRAMATSU, et al.
246909US-90-DIV	10/746,081 🗸	12/29/03	HIRAMATSU, et al.
247451US-90-DIV	10/755,308	01/13/04	HIRAMATSU, et al.
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Shawating Jugua

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### TECHNOLOGY CENTER R3700 **LIST OF RELATED CASES**

Docket Number	Serial or Patent Number	Filing or Issue Date	Inventor/ <u>Applicant</u>
PER CLIENT	09/471,759 🗸	12/23/99	SAITO et al.
PER CLIENT	09/462,067 ✓	01/05/01	FURUKAWA et al.
PER CLIENT	10/345,356	01/16/03	ITO
PER CLIENT	09/787,954 /	03/23/01	ITO
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PER CLIENT	09/787,818 /	03/23/01	OTI
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PER CLIENT	10/182,009 -/	07/24/02	ZHOU

<sup>\*</sup>Present Application; listed for information \*Abandoned Application

MM/sb/akh

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PER CLIENT	10/222,928	08/19/02	ITO
PER CLIENT	10/265,41·3 🗸	10/07/02	OHASHI et al.
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<sup>\*</sup>Present Application; listed for information \*Abandoned Application

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221689US0 DIV	10/118,967· 🗸	04/10/02	ITO et al.
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<sup>\*</sup>Present Application; listed for information \*Abandoned Application

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233937US90 PCT	10/343,833 /	09/22/03	ZHOU et al.
234652US90 CONT	10/386,615	03/13/03	HIRAMATSU et al.
234735US90 CONT	10/387,452 ✓	03/14/03	ITO et al.
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235401US90 CONT	10/397,321	03/27/03	HIRAMATSU et al.
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241064US90 CONT	10/244,008	09/16/02	NIWA
241191US90 CONT	10/670,354 <sup>V</sup>	09/26/03	NIWA
242402US90 CONT	10/658,454	09/10/03	ITO et al.

<sup>\*</sup>Present Application; listed for information \*Abandoned Application MM/sb/akh I:\EM\EMREL\221s-222s\221014US LIST.DOC

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243468US90 PCT	10/473,585	02/13/04	ITO et al.
244440US90 CONT	10/697,287	10/31/03	ITO et al.
245199US90 CONT	10/718,535	11/24/03	HIRAMATSU et al.
246481US90 PCT	09/673,953 /	12/21/00	ITO et al.
246590US90 DIV	10/732,296 ✓	12/11/03	ITO et al.

<sup>\*</sup>Present Application; listed for information #Abandoned Application MM/sb/akh I:\EM\EMREL\221s-222s\221014US LIST.DOC

Docket No.

221014US2PCT

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Yasuji HIRAMATSU, et al.

SERIAL NO:

10/070,443

GAU:

FILED:

June 24, 2002

**EXAMINER:** 

FOR:

CERAMIC HEATER FOR A SEMICONDUCTOR PRODUCING/EXAMINING DEVICE, PROCESS OF PRODUCING THE CERAMIC HEATER, AND PRODUCTION SYSTEM OF THE CERAMIC HEATER

## INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR

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### REFERENCES

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OCT 0 6 2003

TECHNOLOGY CENTER R3700

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Marvin J. Spivak

Registration No. 24,913

Roland E. Martin Registration No. 48,082

Customer Number

22850

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Stx	Docket Number 205295US0 PCT	Patent Number / 09/806,478	<u>Issue Date</u> 07/26/01	Applicant ITO et al.
0-14 0	219658US0 PCT	10/048,989 √	05/29/02	HIRAMATSU et al.
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30	221014US2 PCT*	10/070,443	06/24/02	HIRAMATSU et al.

Shawatina Lugua

6/28/04

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#### TRADEMARK OFFICE IN THE UNITED STATES I

IN RE APPLICATION OF:

Yasuji HIRAMATSU, et al.

SERIAL NO: 10/070,443

GAU:

3742

FILED:

June 24, 2002

EXAMINER: FUQUA, S.T.

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OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Norman F. Oblon

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

Roland E. Martin Registration No. 48,082



# LIST OF RELATED CASES

Docket Number

Serial or Patent Number Filing or **Issue Date**  Inventor/ **Applicant** 

221014US90 PCT\*

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HIRAMATSU, et al.

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HIRAMATSU, et al.

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TECHNOLOGY CENTER R3700

Docket No.

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Yasuji HIRAMATSU, et al.

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GAU:

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FILED:

June 24, 2002

**EXAMINER: SHAWNTINA T. FUQUA** 

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Masayasu Mori

Registration No. 47,301

Joseph A. Scafetta, Jr. Registration No. 26, 803

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

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	AR	10-305606	11/17/1998	JAP	PAN (with English Abstract)			х
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SH	AU	2001-244059	09/07/2001	JAP	PAN (with English Abstract)			х
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